

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Errors
1	IS&R	L8	3686	((359/290,291,295,298,302,311) or (73/720,721,722,723,715) or (216/2) or (438/53)).CCLS.	USP AT; US- PGP UB	2003 /10/ 22 08:5 3		0
2	BRS	L9	429	8 and (mems or micro-electromechanic\$4 or (micro adj electr\$4 adj mechanic\$4))	USP AT; US- PGP UB	2003 /10/ 22 08:5 4		0
3	BRS	L10	389	9 and (sacrificial\$3 or psq or (phosposilicate adj glass) or polysilicon or silicon)	USP AT; US- PGP UB	2003 /10/ 22 08:5 5		0
4	BRS	L11	108	10 and transduc\$4	USP AT; US- PGP UB	2003 /10/ 22 08:5 5		0
5	BRS	L12	77	11 and (diaphragm or (silicon adj1 nitride) or (silicon adj1 dioxide))	USP AT; US- PGP UB	2003 /10/ 22 08:5 6		0
6	BRS	L13	67	12 and ((remov\$4 or etch\$4) with (sacrificial\$3 or psq or (phosposilicate adj glass) or polysilicon or silicon))	USP AT; US- PGP UB	2003 /10/ 22 08:5 6		0
7	BRS	L15	63	12 and ((remov\$4 or etch\$4) near1 (sacrificial\$3 or psq or (phosposilicate adj glass) or polysilicon or silicon))	USP AT; US- PGP UB	2003 /10/ 22 08:5 6		0
8	BRS	L14	4	13 and ((diaphragm or (silicon adj1 nitride) or (silicon adj1 dioxide)) with suspend\$4)	USP AT; US- PGP UB	2003 /10/ 22 08:5 7		0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Errors
9	BRS	L16	11	15 and void\$3	USP AT; US- PGP UB	2003 /10/ 22 08:5 7		0

	Type	L #	Hits	Search Text	DBs	Time Stamp	Comments	Errors
1	BRS	L1	9116	(mems or (micro-electromechanics\$4) or (micro adj electr\$4 adj mechanic\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003 /10/ 22 08:3 2		0
2	BRS	L2	5730	1 and (sacrificial\$3 or psg or (phosphosilicate adj glass) or polysilicon or silicon)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003 /10/ 22 08:3 3		0
3	BRS	L3	2692	2 and (diaphragm or (silicon adj1 nitride) or (silicon adj1 dioxide))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003 /10/ 22 08:3 6		0
4	BRS	L4	7813	3 and transduc\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003 /10/ 22 08:3 5		0
5	BRS	L5	612	4 and ((remov\$4 or etch\$4) with (sacrificial\$3 or psg or (phosphosilicate adj glass) or polysilicon or silicon))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003 /10/ 22 08:3 5		0
6	BRS	L6	534	4 and ((remov\$4 or etch\$4) near3 (sacrificial\$3 or psg or (phosphosilicate adj glass) or polysilicon or silicon))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003 /10/ 22 08:3 5		0
7	BRS	L7	28	6 and ((diaphragm or (silicon adj1 nitride) or (silicon adj1 dioxide)) with suspend\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003 /10/ 22 08:3 6		0